MGFC47A4450

4.4~5.0GHz BAND 50W INTERNALLY MATCHED GaAs FET

DESCRIPTION

The MGFC47A4450 device is an internally impedance-matched GaAs power FET especially designed for use in 4.4 \sim 5.0GHz band amplifiers. The hermetically sealed metal-ceramic package guarantees high reliability.

FEATURES

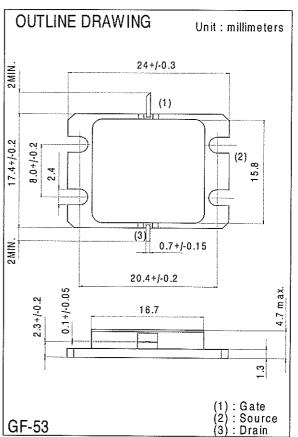
- Class AB operation
- Internally matched to 50(ohm) system
- ♦ High output power P1dB = 47dBm (TYP.) @ f=4.4 ~ 5.0 GHz
- High power gain GLP = 10.5 dB (TYP.) @ f=4.4 ~ 5.0GHz
- ♦ High power added efficiency PAE = 40% (TYP.) @ f=4.4 ~ 5.0GHz

APPLICATION

Radio Link

RECOMMENDED BIAS CONDITIONS

VDS = 10 (V) ID = 9.8 (A) RG=10 (ohm)



ABSOLUTE MAXIMUM RATINGS (Ta=25deg.C)

Symbol	Parameter	Ratings	Unit
VGDO	Gate to drain voltage	-20	V
VGSO	Gate to source voltage	-10	V
IGR	Reverse gate current	-130	mA
IGF	Forward gate current	168	mA
PT *1	Total power dissipation	166	W
Tch	Channel temperature	175	deg.C
Tstg	Storage temperature	-65 / +175	deg.C

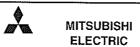
^{*1 :} Tc=25deg.C

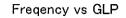
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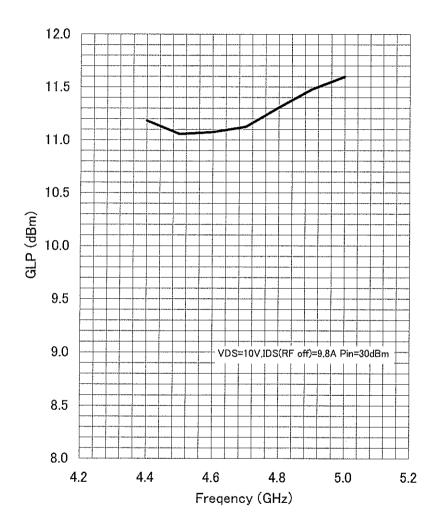
ELECTRICAL CHARACTERISTICS (Ta=25deg.C)

Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Тур.	Max.	1
VGS(off)	Pinch-off voltage	VDS = 3V , ID = 168mA	-1		-4	V
P1dB	Output power at 1dB gain compression		46.0	47.0	-	dBm
GLP	Linear power gain	VDS=10V, ID(RF off)=9.8A, f=4.4 \sim 5.0GHz	9.5	10.5	-	dB
ID	Drain Current		_	11	_	A
PAE	Power added efficiency			40	_	%
Rth(ch-c)	Thermal resistance *1	delta Vf method	-	0.8	0.9	deg.C/W

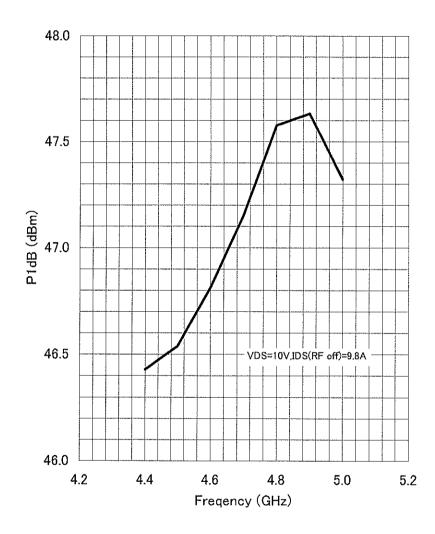
^{*1 :} Channel-case







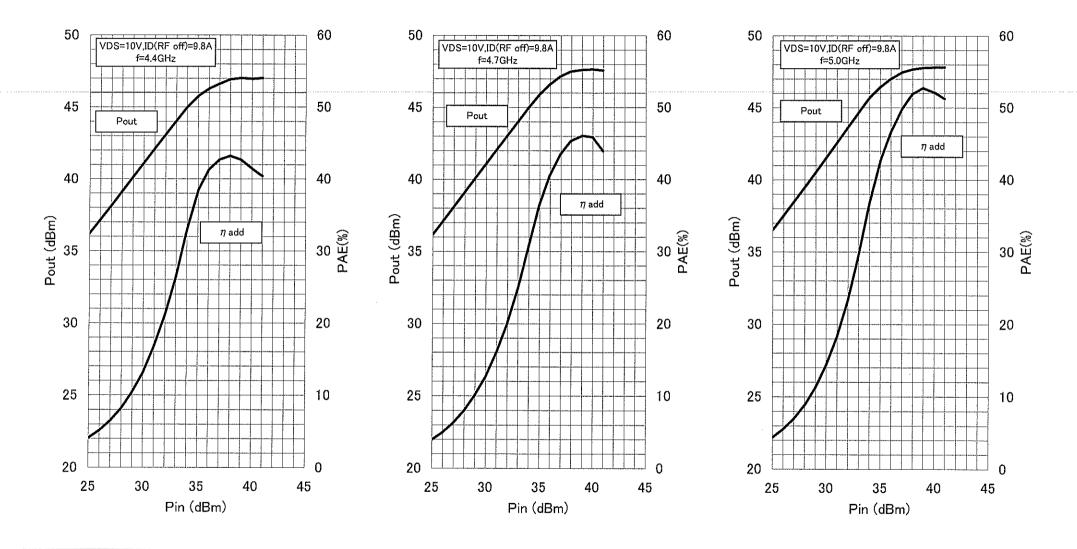
Frequency vs P1dB



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OUTPUT POWER & POWER ADDED EFFICIENCY vs. INPUT POWER



MITSUBISHI ELECTRIC CORP.

HIGH FREQUENCY & OPTICAL SEMICONDUCTOR DIV.

S PARAMETERES(T=25deg.C,VDS=10V,ID=8.0A)

	S Parameters(TYP.)								
f	S11		Sź	S21		S12		S22	
(GHz)	MAG.	ANG(deg.)	[MAG]	[ANG]	[MAG]	[ANG]	[MAG]	[ANG]	
4.20	0.776	24.3	2.862	177.9	0.034	126.1	0.269	57.6	
4.25	0.745	14.8	3.067	168.4	0.039	113.5	0.234	47.0	
4.30	0.707	3.9	3.276	158.5	0.044	102.5	0.199	36.2	
4.35	0.663	-7.9	3.475	148.0	0.049	90,3	0.166	21.3	
4.40	0.615		3.654	137.2	0.055	78.5	0.130	3.7	
4.45	0.567	-35.2	3.836	126.1	0.060	66.1	0.103	-20.4	
4.50	0.513	-51.0	3.971	114.6	0.065	54.5	0.086	-49.2	
4.55	0.465	-68.2	4.092	102.9	0.070	42.4	0.080	-83.3	
4.60	0.421	-87.1	4.162	91.1	0.074	30.3	0.086	114.7	
4.65	0.381	-107.9	4.190	79.1	0.077	18.1	0.099	-143.6	
4.70	0.354	-130.1	4.178	67.2	0.081	6,9	0.117	-166.6	
4.75	0.334	-153.4	4.126	55.5	0.082	-4.8	0.136	172.9	
4.80	0.327	-176.8	4.033	43.7	0.084	-15.6	0.156	155.5	
4.85	0.331	160.4	3.921	32.5	0.085	-26.5	0.178	138.1	
4.90	0.341	139.1	3.784	21.4	0.086	-37.4	0.204	122.1	
4.95	0.360	120.3	3.643	10.7	0.086	-48.3	0.231	107.3	
5.00	0.394	103.0	3.514	0.2	0.086	-58.6	0.262	93.9	
5.05	0.436	86.8	3.366	-10.6	0.085	-68.9	0.295	80.8	
5.10	0.482	71.3	3.204	-21.4	0.083	-79.5	0.333	68.9	
5.15	0.526	56.9	3.026	-32.0	0.080	-89.8	0.369	57.6	
5.20	0.571	43.7	2.844	-42.4	0.078	-99.9	0.412	47.2	

This S-Parameter data show measurements performed on each single-ended FET

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